



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SERIES 897 • UNIVERSAL SERIAL BUS 3.0 MICRO-B • SURFACE MOUNT SOCKETS

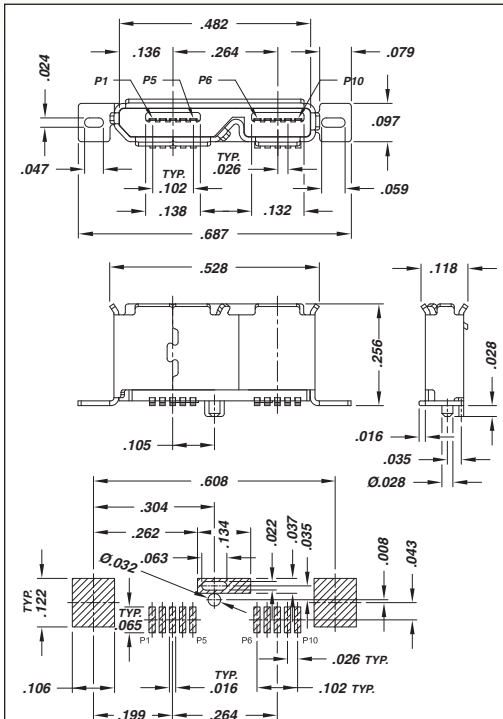


FIG. 1

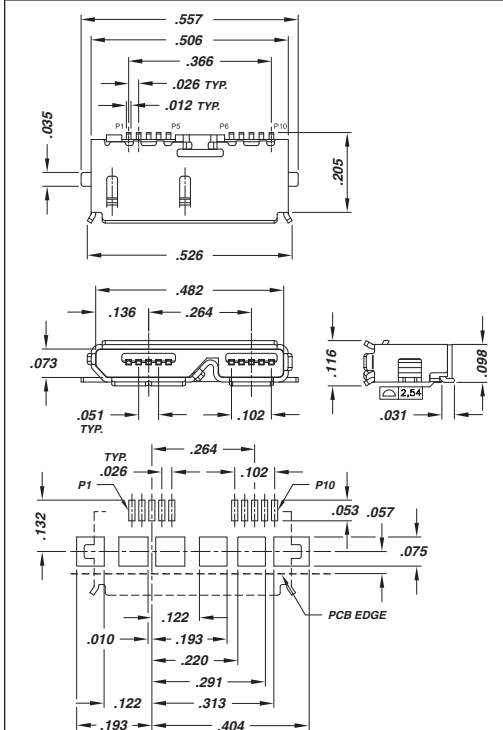


FIG. 2

- USB 3.0 Micro-B receptacles for surface mount
- Reduced mounting space
- Fully shielded
- Fully backwards compatible with USB 2.0
- 10X faster than USB 2.0 and provides optimized power efficiency
- Smaller and lighter than existing USB connectors, for portable & handheld devices
- Packaged on Tape and Reel:
897-10-010-00-300002 - 900 pieces per reel
897-10-010-40-300002 - 1,500 pieces per reel



ORDERING INFORMATION

FIG. 1	Micro Type B Receptacle, Single, Vertical Surface Mount
	897-10-010-00-300002
FIG. 2	Micro Type B Receptacle, Single, Surface Mount
	897-10-010-40-300002

Technical Specifications

Materials:

Terminals: Copper Alloy, Gold Flash over Ni
Contacts: Copper Alloy, 15 μ" Gold-Plated over Ni
Shell material: Stainless Steel, Nickel-Plated
Insulator material: High temperature LCP thermoplastic rated UL94V-0



Ratings:

Voltage: 30VAC (rms)
Current: 1.5A (Pin 1 and 5), .25A (other pins)
All housing materials rated for "lead-free" soldering up to 260° C

Electrical:

Contact resistance: 30mΩ max. (Pin 1 and 5)
50mΩ max. (other pins)
Insulation resistance: 100MΩ min.
Dielectric withstanding voltage: 100VAC for 1 minute at sea level

Mechanical:

Random vibration: No discontinuity >1μs per EIA 364-28, cond. V, letter A
Durability: 10,000 cycles max. per EIA 364-09
Mating force: 35 Newtons max. per EIA 364-13
Unmating force: Initial - 10 Newtons min. per EIA 364-13
After test - 8 Newtons min. per EIA 364-13

Environmental:

Operating Temperature Range: -40°C to +85°C
Humidity per EIA 364-31, method II, condition A
Temperature Life per EIA 364-17, condition 3, method A
Solderability per EIA 364-52, category 2 (260°C for 3 seconds)